



EXPEDITED PROCEDURE – EXAMINING GROUP 2815

10/607,782

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:	Sabina J. Houle	Examiner:	Matthew Warren
Serial No.:	10/607,782	Group Art Unit:	2815
Filed:	June 27, 2003	Docket No.:	884.860US1
Title:	LIQUID SOLDER THERMAL INTERFACE MATERIAL CONTAINED WITHIN A COLD-FORMED BARRIER AND METHODS OF MAKING SAME		
Assignee:	Intel Corporation	Customer Number:	21186

AMENDMENT & RESPONSE UNDER 37 C.F.R. 1.116

Mail Stop AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

In response to the Final Office Action mailed May 18, 2005, please amend the application as follows: